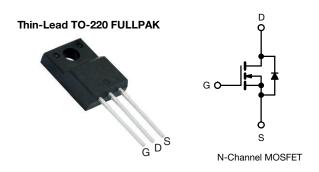
Vishay Siliconix

COMPLIANT

HALOGEN

**FREE** 

## **E Series Power MOSFET**



PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	65	50
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.155
Q <sub>g</sub> max. (nC)	3	3
Q <sub>gs</sub> (nC)	7	7
Q <sub>gd</sub> (nC)	1	1
Configuration	Sin	gle

#### **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA180N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	600	V
Gate-source voltage		$V_{GS}$	± 30	v	
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		9	
Continuous drain current (1) = 150 °C) -	VGS at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	6	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	44	
Linear derating factor				0.26	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	111	mJ
0, 1		33	W		
Operating junction and storage temperature ran	nge		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dv/dt	100	V/ns	
Reverse diode dv/dt <sup>d</sup>			dv/di	22	V/IIS
Soldering recommendations (peak temperature	e) <sup>c</sup>	For 10 s		260	°C
Mounting torque, M3 screw		•		0.6	Nm

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 2.8 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C
- e. Limited by maximum junction temperature



# Vishay Siliconix

THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	$R_{thJA}$	-	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	3.8	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							•
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Cata aguras lagkaga	1	,	V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Gate-source leakage	$I_{GSS}$	,	$V_{GS} = \pm 30 \text{ V}$		-	± 1	μΑ
Zoro goto voltago drain ourrent		V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 9.5 A		0.155	0.180	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 9.5 A		-	5.3	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ ,			1085	-	pF
Output capacitance	C <sub>oss</sub>	╗,	$V_{DS} = 100 \text{ V},$		56	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V 0VV 400V V 0V		-	41	-	
Effective output capacitance, time related <sup>b</sup>	$C_{o(tr)}$	V <sub>DS</sub> = 0	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		251	-	
Total gate charge	$Q_g$			-	22	33	
Gate-source charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$	$I_D = 9.5 \text{ A}, V_{DS} = 480 \text{ V}$	-	7	-	nC
Gate-drain charge	$Q_gd$			-	11	-	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD}$ = 480 V, $I_{D}$ = 9.5 A, $V_{GS}$ = 10 V, $R_{g}$ = 9.1 $\Omega$		-	14	28	
Rise time	t <sub>r</sub>			-	49	98	ne
Turn-off delay time	$t_{d(off)}$			-	22	44	ns
Fall time	t <sub>f</sub>			-	23	46	
Gate input resistance	$R_{g}$	f = 1 MHz, open drain		0.3	0.7	1.4	Ω
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	
Pulsed diode forward current	I <sub>SM</sub>			-	-	44	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 9.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	-		-	282	564	ns
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, $I_F = I_S = 9.5 \text{ A}$ , di/dt = 100 A/ $\mu$ s, $V_R = 25 \text{ V}$		-	3.6	7.2	μC
Reverse recovery current	I <sub>RRM</sub>			_	24	-	Α

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

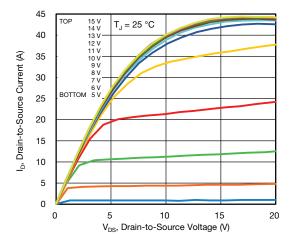


Fig. 1 - Typical Output Characteristics

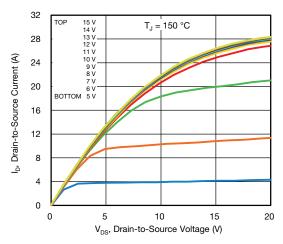


Fig. 2 - Typical Output Characteristics

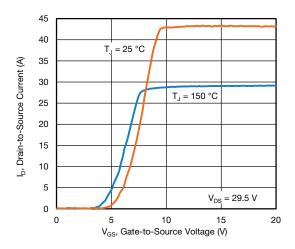


Fig. 3 - Typical Transfer Characteristics

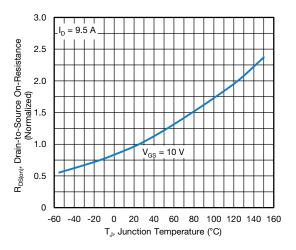


Fig. 4 - Normalized On-Resistance vs. Temperature

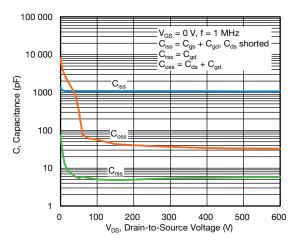


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

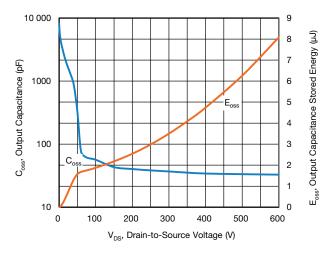


Fig. 6 -  $C_{oss}$  and  $E_{oss}$  vs.  $V_{DS}$ 



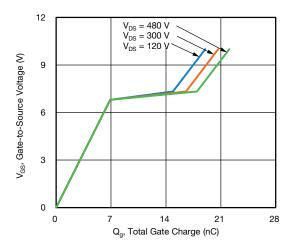


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

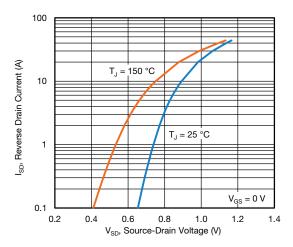


Fig. 8 - Typical Source-Drain Diode Forward Voltage

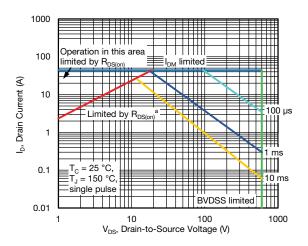


Fig. 9 - Maximum Safe Operating Area



a.  $V_{GS} > minimum \ V_{GS}$  at which  $R_{DS(on)}$  is specified

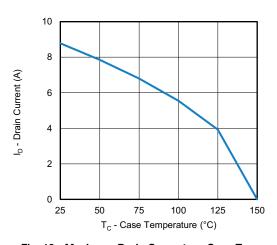


Fig. 10 - Maximum Drain Current vs. Case Temperature

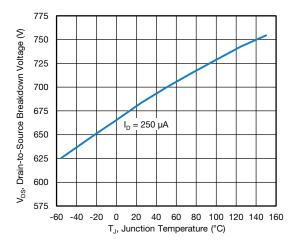


Fig. 11 - Temperature vs. Drain-to-Source Voltage



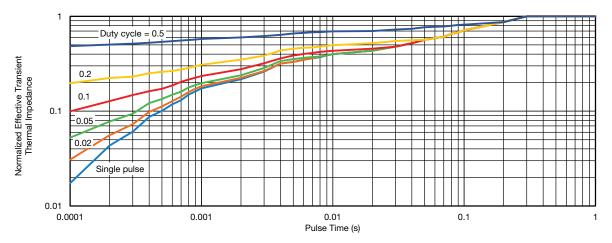


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

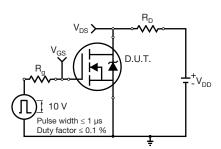


Fig. 13 - Switching Time Test Circuit

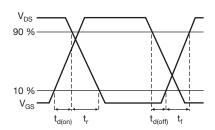


Fig. 14 - Switching Time Waveforms

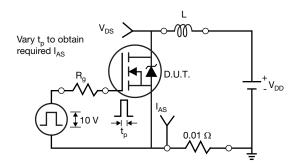


Fig. 15 - Unclamped Inductive Test Circuit

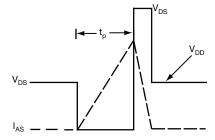


Fig. 16 - Unclamped Inductive Waveforms

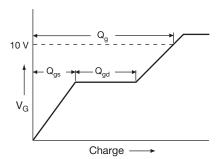


Fig. 17 - Basic Gate Charge Waveform

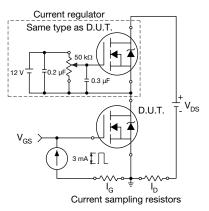


Fig. 18 - Gate Charge Test Circuit



### Peak Diode Recovery dv/dt Test Circuit

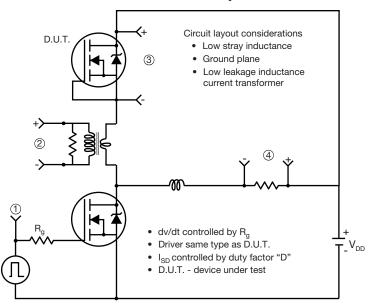




Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL	DIMENSIONS				
	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	=	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
Е	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØP	3.00	3.40	0.118	0.134	

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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